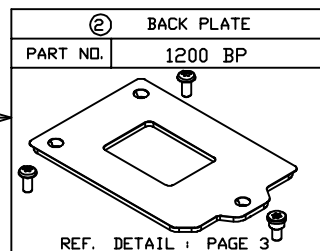
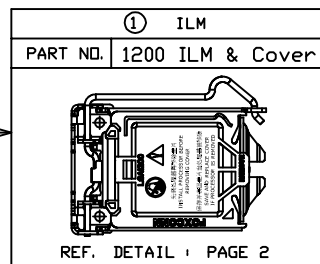
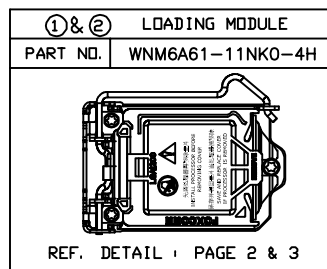


IDEAS GENERATED DRAWING, DO NOT CHANGE BY HAND.

REV.	ECN. NO.	APPD.
A	BC-20-0023074	Nick.Lin



NOTES:

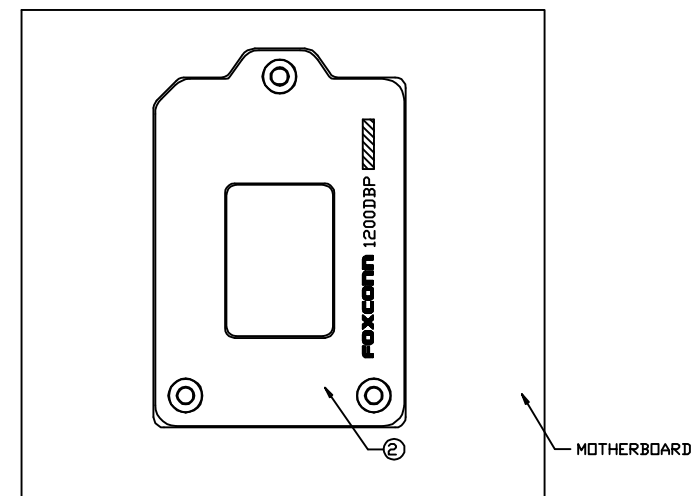
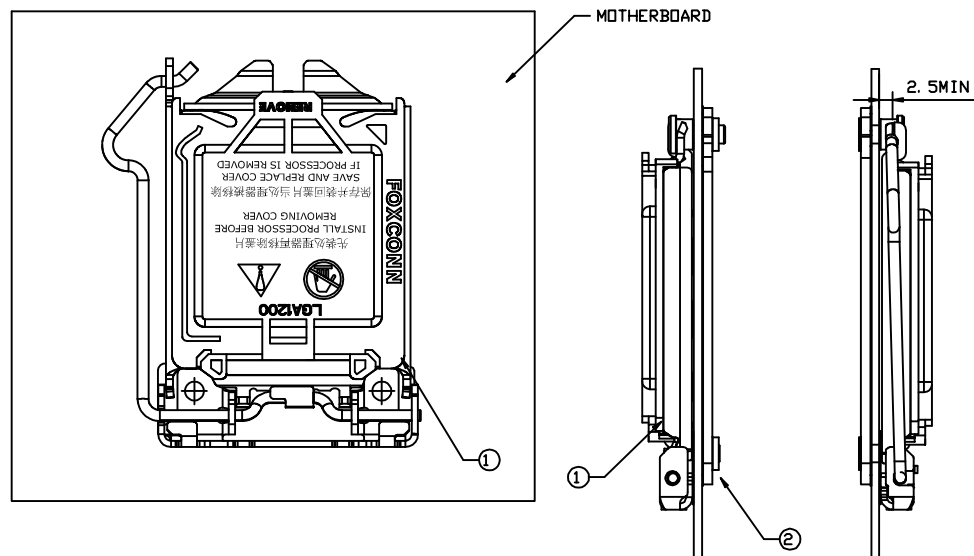
1. ASSEMBLY PROCEDURE.

- SMT SOCKET ON BOARD BY PROPER FIXTURE & SUGGESTED PROFILE;
- FASTEN THE ILM & BACK PLATE BY PROPER SCREW DRIVER;
- LIFT UP LEVER TO ACTUATE LOAD PLATE FOR OPEN ILM;
- REMOVE PICK & PLACE CAP;
- FOLLOW THE ALIGNMENT KEY ORIENTATION TO INSERT CPU PROPERLY ;
- ACTUATE LEVER TO CLOSE LOAD PLATE;
- PUSH DOWN LEVER TO LOCK POSITION;
- CPU WORKS AFTER THE ABOVE PROCEDURE FINISHED.

2. HARMFUL MATERIAL CONTROL PLEASE FOLLOWS DOC. NO. "EP112";
(COMPLIANT TO RoHS)

3. THE CONCENTRATIONS OF Br AND Cl CAN SATISFY THE REQUIREMENT
OF HALOGEN-FREE IN DOCUMENT "EP112".

4. PLEASE CONTACT FOXCONN SALES REPRESENTATIVE TO VERIFY
PRODUCT DETAILS & AVAILABILITY.



X. ± 0.30	X. ° ± 1°	UNITS	mm	NAME<INTENDED USE>	 FOXCONN INTERCONNECT TECHNOLOGY LIMITED.		
. X ± 0.20	. X ° ±	MAT'L		LGA1200 ILM&COVER			
. XX ± 0.10	. XX ° ±			PART NO.<INTENDED USE>	CLASS: ☐ CONFIDENTIAL ☐ SECRET ☒ GENERAL		
. XXX ±	. XXX ° ±	FINISH		WNM6A61-11NKO-4H	TITLE: CUSTOMER DRAWING FOR 1200 SOCKET H		
THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF FOXCONN INTERCONNECT TECHNOLOGY LIMITED AND SHALL NOT BE REPRODUCED, COPIED OR USED IN ANY MANNER WITHOUT THE PRIOR WRITTEN CONSENT OF FOXCONN INTERCONNECT TECHNOLOGY LIMITED.				APPD: Nick Lin	DWG NO. : 351-0000-1662		
				Q' TY	CHKD: Mac Peng		
				DR: Dane Dong 9/1'20			
						SCALE SHEET REV. 1: 1 1/4 A	

IDEAS GENERATED DRAWING, DO NOT CHANGE BY HAND.

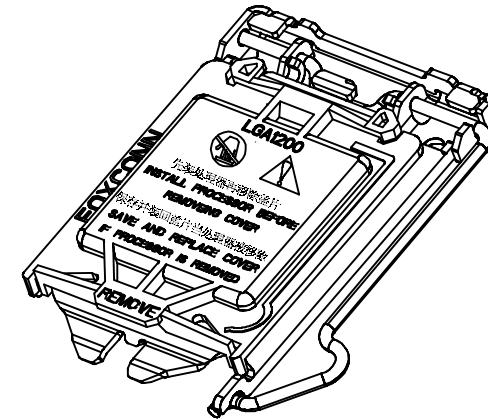
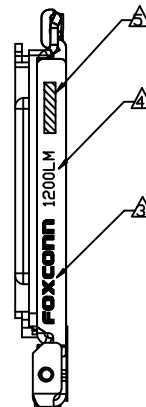
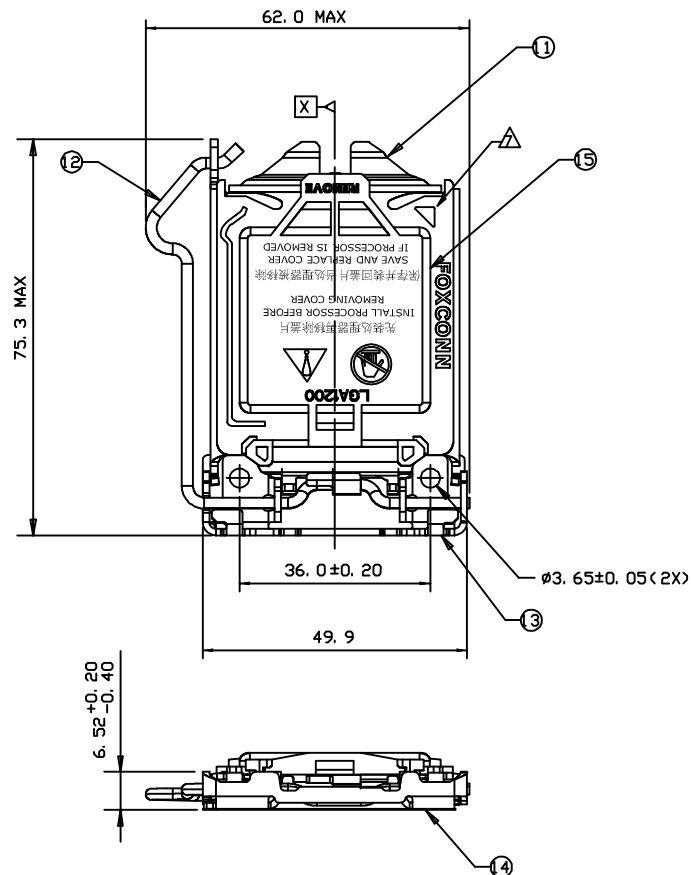
REV.	ECN. NO.	APPD.

COMPONENT LIST		
ITEM	DESCRIPTION	Q' TY
①	LOAD PLATE	1
②	LEVER	1
③	FRAME	1
④	FRAME INSULATOR	1
⑤	ILM COVER	1

NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- MATERIAL :

LOAD PLATE	STAINLESS STEEL;
FRAME	CARBON STEEL WITH NI PLATING;
LEVER	STAINLESS STEEL ;
INSULATOR	PET,UL94VTM-0,HALOGEN FREE;
COVER	PC/ABS,BLACK;
- FOXCONN LOGO IS LOCATED APPROXIMATELY;
- SOCKET LOGO IS LOCATED APPROXIMATELY;
- DATE CODE IS LOCATED APPROXIMATELY;
- HARMFUL MATERIAL CONTROL PLEASE FOLLOWS DOC. NO. "EPI12";
(COMPLIANT TO RoHS)
- PLEASE CONTACT FOXCONN SALES REPRESENTATIVE TO VERIFY PRODUCT DETAILS & AVAILABILITY.



X. ± 0.30	X. ° ± 1°	UNITS mm	NAME<INTENDED USE> LGA1200 ILM&BP	 FOXCONN INTERCONNECT TECHNOLOGY LIMITED.			
. X ± 0.25	. X ° ±	MAT' L					
. XX ± 0.13	. XX ° ±	FINISH	PART NO. <INTENDED USE> WNM6A61-11NKO-4H	CLASS: ☐ CONFIDENTIAL ☐ SECRET ☒ GENERAL			
. XXX ±	. XXX ° ±		APPD: Nick Lin	TITLE: CUSTOMER DRAWING FOR 1200 SOCKET H			
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			DR: Dane Dong 9/1'20	 <table><tr><td>SCALE</td><td>SHEET</td><td>REV.</td></tr><tr><td>1: 1</td><td>2/4</td><td>A</td></tr></table>	SCALE	SHEET	REV.
SCALE	SHEET	REV.					
1: 1	2/4	A					

IDEAS GENERATED DRAWING, DO NOT CHANGE BY HAND.

REV.	ECN. NO.	APPD.

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.

△ MATERIAL : BACK PLATE CARBON STEEL WITH NI PLATING;
INSULATOR PET,UL94VTM-0,HALOGEN FREE;
SCREW CARBON STEEL;

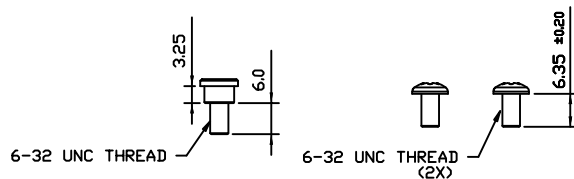
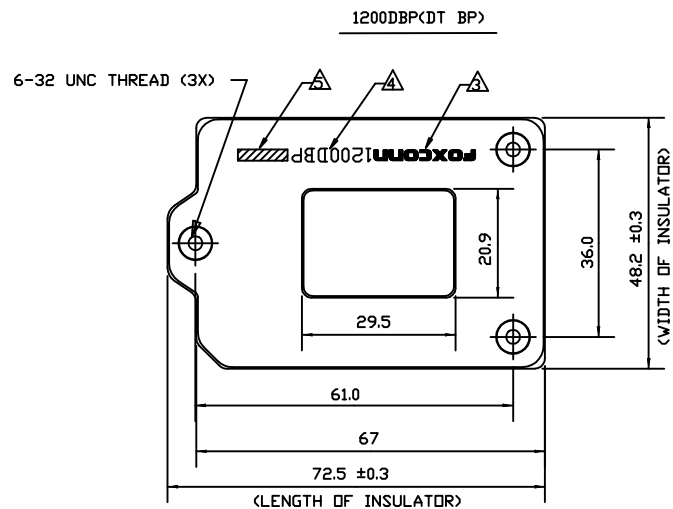
△ FOXCONN LOGO IS LOCATED APPROXIMATELY;

△ SOCKET LOGO IS LOCATED APPROXIMATELY;

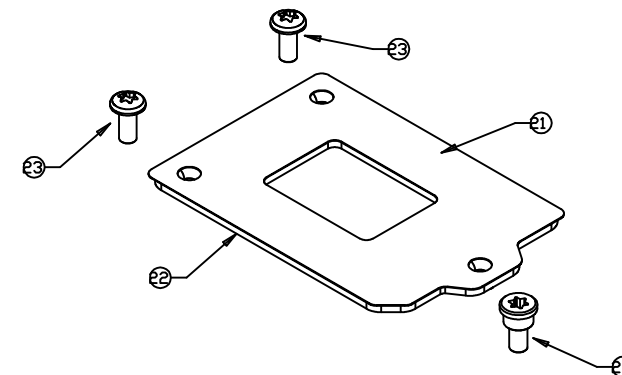
△ DATE CODE IS LOCATED APPROXIMATELY;

6. HARMFUL MATERIAL CONTROL PLEASE FOLLOWS DOC. NO. "EPH12";
(COMPLIANT TO RoHS)

7. PLEASE CONTACT FOXCONN SALES REPRESENTATIVE TO VERIFY PRODUCT DETAILS & AVAILABILITY.



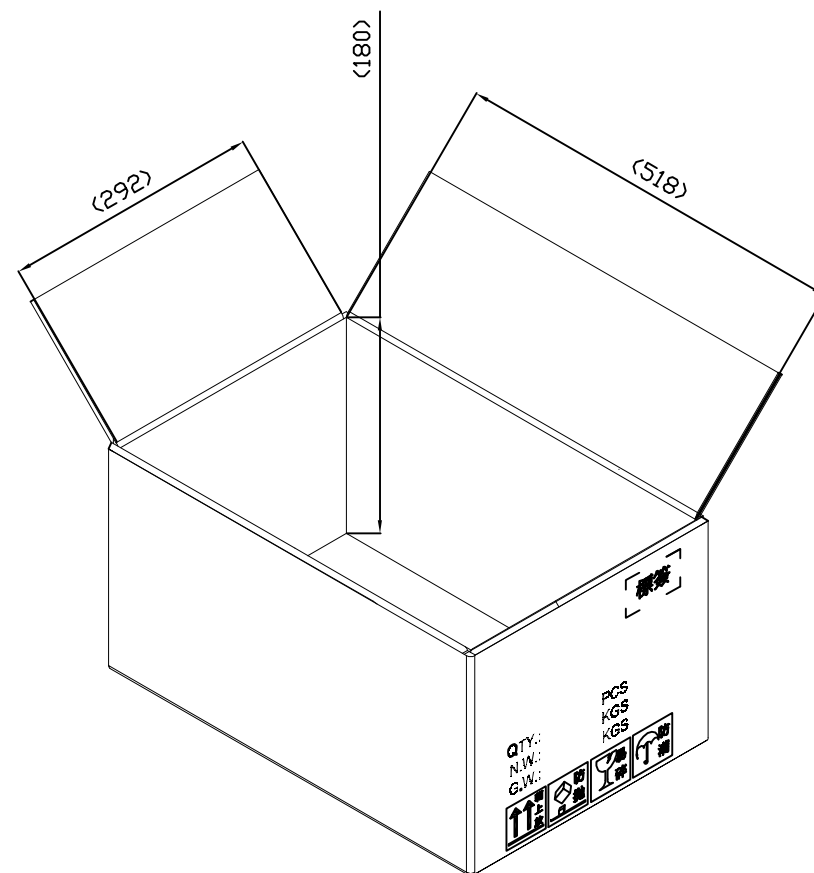
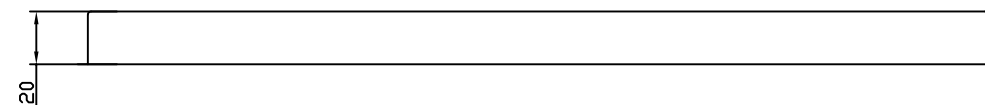
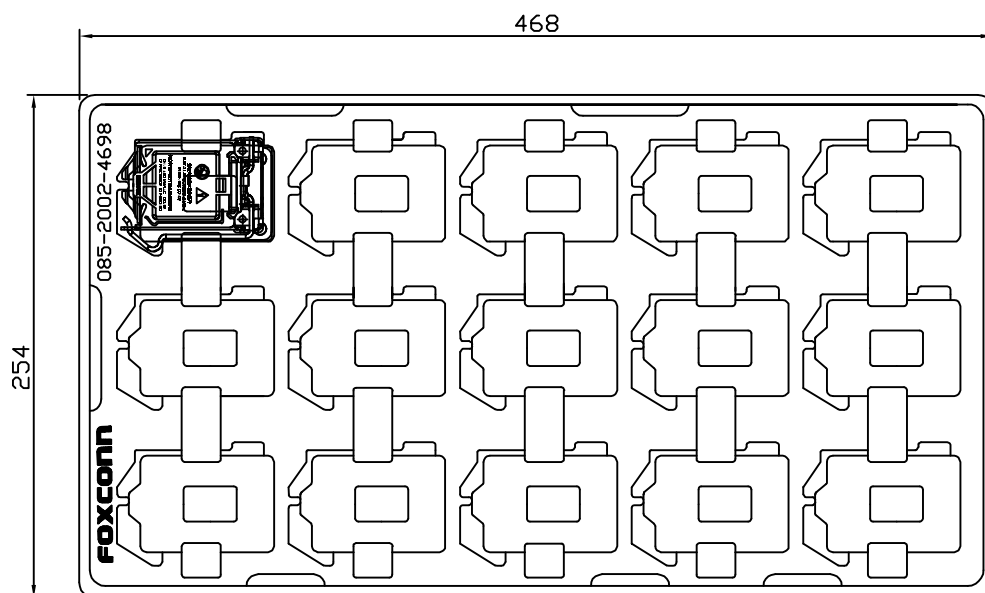
COMPONENT LIST		
ITEM	DESCRIPTION	Q' TY
①	BACK PLATE	1
②	INSULATOR	1
③	TORX SCREW	2
④	SHOULDER SCREW	1



X. ± 0.30	X. ° ± 1°	UNITS mm	NAME<INTENDED USE> LGA1200 BP		FOXCONN INTERCONNECT TECHNOLOGY LIMITED.		
. X ± 0.20	. X ° ±	MAT'L	PART NO. <INTENDED USE> WNM6A61-11NKO-4H		CLASS: ☐ CONFIDENTIAL ☐ SECRET ☒ GENERAL		
. XX ± 0.10	. XX ° ±	FINISH	APPD: Nick Lin	TITLE: CUSTOMER DRAWING FOR 1200 SOCKET H			
. XXX ±	. XXX ° ±		Q' TY	CHKD: Mac Peng	DWG NO. 351-0000-1662		
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						REV. A	

IDEAS GENERATED DRAWING,DO NOT CHANGE BY HAND.

REV. ECN. NO. APPD.



NOTES : 15PCS/TRAY , 120PCS/CARTON .

X. ± 3	X. ° ± 0.5°	UNITS mm	NAME<INTENDED USE> LGA1200 SOCKET H	 FOXCONN INTERCONNECT TECHNOLOGY LIMITED.	
.X ± 1	.X ° ±	MAT'L	PART NO.<INTENDED USE> WNM6A61-11NK0-4H		
.XX ±	.XX ° ±	FINISH	APPD: Nick Lin	CLASS: ☐ CONFIDENTIAL ☐ SECRET ☒ GENERAL	
.XXX ±	.XXX ° ±		CHKD: Mac Peng	TITLE: CUSTOMER DRAWING FOR 1200 SOCKET H	
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				 SCALE SHEET REV. 1:4 4/4 A	